

	Type	L #	Hits	Search Text	DBs
1	BRS	L1	2468	257/666.ccls.	US-PGPUB; USPAT; USOCR
2	BRS	L3	401	257/702.ccls.	US-PGPUB; USPAT; USOCR
3	BRS	L4	2025	257/723.ccls.	US-PGPUB; USPAT; USOCR
4	BRS	L5	1393	257/724.ccls.	US-PGPUB; USPAT; USOCR
5	BRS	L6	34	L2 and TAB and leadframe	US-PGPUB; USPAT; USOCR
6	BRS	L7	1	"4805009".PN.	USPAT; USOCR
7	BRS	L8	1	"4721992".PN.	USPAT; USOCR
8	BRS	L9	1	"4706811".PN.	USPAT; USOCR
9	BRS	L10	1	"4701781".PN.	USPAT; USOCR
10	BRS	L11	257	257/668.ccls.	EPO; JPO; DERWENT; IBM_TDB
11	BRS	L12	136	257/702.ccls.	EPO; JPO; DERWENT; IBM_TDB
12	BRS	L13	39	(TAB adj leadframe) and (board or substrate) and lead and (chip or component or die) and (perimeter or peripher\$2)	US-PGPUB; USPAT; USOCR

	Type	L #	Hits	Search Text	DBs
13	BRS	L14	1	((TAB adj leadframe) and (board or substrate) and lead and (chip or component or die) and (perimeter or peripher\$2) and (inner or outer)).clm.	US-PGPUB
14	BRS	L2	1048	257/668.ccls.	US-PGPUB; USPAT; USOCR
15	BRS	L15	124	257/E23.066.ccls	EPO; JPO